

In the Claims:

Please cancel claims 1-7 and 10-13 without prejudice.

1. (Cancelled)

2. (Cancelled)

3. (Cancelled)

4. (Cancelled)

5. (Cancelled)

6. (Cancelled)

7. (Cancelled)

8. (Original) A manufacturing method of an electromagnetic interference (EMI) shielding filter, the method comprising the steps of:

preparing a base film;

forming on the base film a first blackened layer and a conductive layer;

patterning the first blackened layer and the conductive layer by using a same mask, and forming on the rear surface of an EMI shielding layer a conductive pattern comprising the first blackened layer; and

forming a second, third, and fourth blackened layer for encompassing a front surface and both side surfaces of the conductive pattern.

9. (Original) The method according to claim 8, wherein the second, third and fourth blackened layers are formed by an electroless plating, screen printing or thin film coating process.

10. (Cancelled)

11. (Cancelled)

12. (Cancelled)

13. (Cancelled)